

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S49	102	"29"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:07
S50	21	"294"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:09
S51	95	"356"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:20
S52	21	"228"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:24
S53	8	("5257714").URPN.	USPAT	OR	ON	2005/05/17 16:21
S54	10	("3641648" "3713575" "4604648" "4675993" "4677473" "4728195" "4813588" "4848639" "4970380" "5033665").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 16:22
S55	15	("5044072").URPN.	USPAT	OR	ON	2005/05/17 16:22
S56	24	"901"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:27
S57	6	("4793707" "5012115" "5131139" "5224262" "5471310" "6292261").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 16:24
S58	4	"174"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:27
S59	10	"361"/\$ and mounting with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:29

S60	97	(bonding mounting) near4 (head unit) with (component ic chip semiconductor substrate board) and light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:37
S61	6	("5359203").URPN.	USPAT	OR	ON	2005/05/17 16:35
S62	5	(bonding mounting) near4 (head unit) and (flex\$5 lead trace pad terminal) near4 (component substrate board) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:40
S63	3	29/833 and (bonding mounting) near4 (head unit) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:41
S64	4	29/833 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:41
S65	2	29/832 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:41
S66	0	29/832.ccls. and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:41
S67	2	29/720 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:42
S68	9	29/721 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:43
S69	0	29/738 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:43
S70	2	29/741 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:44
S71	5	29/743 and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:44

S72	3	"294"/\$ and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:45
S73	21	"356"/\$ and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:46
S74	3	"228"/\$ and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 16:47
S75	4	"901"/\$ and (bonding mounting) and light near2 (source path) with (vacuum suck\$3 suction) near2 (chuck head nozzle)	USPAT; EPO; JPO	OR	ON	2005/05/17 17:42
S76	46	(bond\$3 mount\$3) with (substrate board lead\$1frame) and light near2 (source path) same (vacuum suck\$3 suction) near2 (chuck head nozzle) and camera	USPAT; EPO; JPO	OR	ON	2005/06/02 16:48
S77	3	(bond\$3 mount\$3) with (lcd lpd acf tft tcp) and light near2 (source path) same (vacuum suck\$3 suction) near2 (chuck head nozzle) and camera	USPAT; EPO; JPO	OR	ON	2005/05/17 17:48
S78	7	("4943732").URPN.	USPAT	OR	ON	2005/05/17 17:49
S79	8	("5501004").URPN.	USPAT	OR	ON	2005/05/17 17:49
S80	24	("3648354" "3962714" "4569574" "4634227" "4648686" "4703559" "4802744" "4950527" "4964700" "5074648" "5288006" "5398863" "5489749" "5501004" "5506919" "5523920" "5653017" "5698068" "5743459" "5943217" "6023075" "6094294" "6104462" "6195139").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 17:50
S81	20	("4964700").URPN.	USPAT	OR	ON	2005/05/17 17:52
S82	8	("5501004").URPN.	USPAT	OR	ON	2005/05/17 17:54
S83	10	("4393579" "4480780" "4796357" "4868973" "4876791" "4956911" "5207467" "5501004" "5591295" "5628660").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 17:55

S84	24	("3648354" "3962714" "4569574" "4634227" "4648686" "4703559" "4802744" "4950527" "4964700" "5074648" "5288006" "5398863" "5489749" "5501004" "5506919" "5523920" "5653017" "5698068" "5743459" "5943217" "6023075" "6094294" "6104462" "6195139").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 17:56
S85	5	("6089442").URPN.	USPAT	OR	ON	2005/05/17 17:57
S86	8	("5501004").URPN.	USPAT	OR	ON	2005/05/17 17:58
S87	5	("3774834" "3949925" "4967261" "5177596" "5276961").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 17:58
S88	7	("4943732").URPN.	USPAT	OR	ON	2005/05/17 18:03
S89	17	light near2 (source path) same (vacuum suck\$3 suction) near2 (chuck head nozzle) with (reference mark)	USPAT; EPO; JPO	OR	ON	2005/06/02 16:51
S90	9	light near2 (source path) and (vacuum suck\$3 suction) near2 (chuck head nozzle) with (reference mark) near3 (component ic chip ec)	USPAT; EPO; JPO	OR	ON	2005/06/02 16:51